

DATA SHEET

GENERAL PURPOSE CHIP RESISTORS RC2010 5%, 1%

RoHS compliant





YAGEO Phicomp

Chip Resistor Surface Mount | RC | SERIES | 2010 (RoHS Compliant)

<u>SCOPE</u>

This specification describes RC2010 series chip resistors with lead-free terminations made by thick film process.

APPLICATIONS

• All general purpose application

FEATURES

- Halogen Free Epoxy
- RoHS compliant
 - Products with lead free terminations meet RoHS requirements
 - Pb-glass contained in electrodes, resistor element and glass are exempted by RoHS
- Reducing environmentally hazardous wastes
- High component and equipment reliability
- Saving of PCB space
- None forbidden-materials used in products/production

ORDERING INFORMATION - GLOBAL PART NUMBER & 12NC

Both part numbers are identified by the series, size, tolerance, packing type, temperature coefficient, taping reel and resistance value.

YAGEO BRAND ordering code

GLOBAL PART NUMBER (PREFERRED)

RC2010	<u>X</u>	<u>K</u> -	<u>XX</u>	<u>XXXX</u>	L
	(I) ((2) (3)) (4)	(5)	(6)

(I) TOLERANCE

 $F = \pm 1\%$

 $J = \pm 5\%$ (for Jumper ordering, use code of J)

(2) PACKAGING TYPE

K = Embossed taping reel

(3) TEMPERATURE COEFFICIENT OF RESISTANCE

- = Base on spec

(4) TAPING REEL

07 = 7 inch dia. Reel

(5) RESISTANCE VALUE

There are $2\sim4$ digits indicated the resistor value. Letter R/K/M is decimal point, no need to mention the last zero after R/K/M, e.g. IK2, not IK20.

Detailed resistance rules show in table of "Resistance rule of global part number".

(6) DEFAULT CODE

Letter L is system default code for order only ^(Note)

Resistance code rul	e Example
0R	0R = Jumper
XRXX (1 to 9.76 Ω)	R = Ω R5 = .5 Ω 9R76 = 9.76 Ω
XXRX (10 to 97.6 Ω)	10R = 10 Ω 97R6 = 97.6 Ω
XXXR (100 to 976 Ω)	100R = 100 Ω
XKXX (1 to 9.76 K Ω)	ικ = 1,000 Ω 9κ76 = 9760 Ω
XMXX (1 to 9.76 M Ω)	IM = 1,000,000 Ω 9M76= 9,760,000 Ω

ORDERING EXAMPLE

The ordering code of a RC2010 chip resistor, value 56 Ω with ±1% tolerance, supplied in 7-inch tape reel is: RC2010FK-0756RL.

NOTE

- All our RSMD products meet RoHS compliant and Halogen Free. "LFP" of the internal 2D reel label mentions "Lead Free Process"
- 2. On customized label, "LFP" or specific symbol can be printed

Chip Resistor Surface Mount RC SERIES 2010 (ROHS Compliant)

3

PHYCOMP BRAND ordering codes

Both GLOBAL PART NUMBER (preferred) and I2NC (traditional) codes are acceptable to order Phycomp brand products.

GLOBAL PART NUMBER (PREFERRED)

For detailed information of GLOBAL PART NUMBER and ordering example, please refer to page 2.

12NC CODE

2322 (I)		(2) (3) (4)		Last di Resistance	git of 12N e decade ⁽³		Last digit
TYPE/ STAR	T TOL.	RESISTANCE	EMBOSSED TAPE ON REEL (units) ⁽²⁾	0.01 to 0.0)976 Ω		0
2010 IN ⁽¹⁾	(%)	RANGE	4,000	0.1 to 0.97	76 Ω		7
PRCI 1 2322	±5%	l to 22 MΩ	760 60xxx	l to 9.76 9	Ω		8
PRC111 2322	±1%	l to 10 MΩ	761 6xxxx	10 to 97.6	Ω		9
Jumper 2322	_	0 Ω	760 90003	100 to 976	6Ω		I
<u> </u>	store hav	vo a 12 digit and	aring code starting with 2222	l to 9.76 l	<Ω		2
		-	ering code starting with 2322.	10 to 97.6	KΩ		3
. ,	•	1 or 5 digits indi	cate the resistor tolerance and	100 to 976	6 ΚΩ		4
packagir	•			l to 9.76 l	MΩ		5
· · ·	-	• ·	sent the resistance value with the	10 to 97.6	MΩ		6
-	git of 12N	• ·	as shown in the table of	Example:	0.02 Ω	=	0200 or 200
(4) Letter L	is systen	n default code fo	or order only ^(Note)		0.3 Ω	=	3007 or 307
Ordering	EXAMPLE	E			ΙΩ	=	1008 or 108
The orderin	o code o	f a PRCIII resig	stor, value 56 Ω with ±1% tolerance,		33 KΩ	=	3303 or 333
	tape of 4,		rel is: 232276165609L or		10 MΩ	=	1006 or 106

ΝΟΤΕ

I. All our RSMD products meet RoHS compliant and Halogen Free. "LFP" of the internal 2D reel label mentions "Lead Free Process"

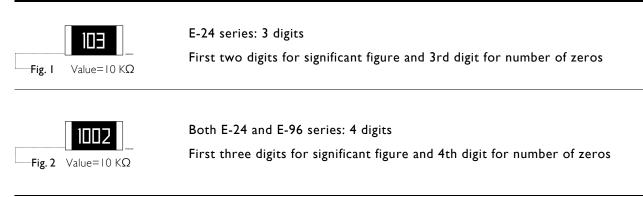
2. On customized label, "LFP" or specific symbol can be printed

YAGEO Phicomp

Chip Resistor Surface Mount RC SERIES 2010 (RoHS Compliant)

MARKING

RC2010



For further marking information, please see special data sheet "Chip resistors marking".

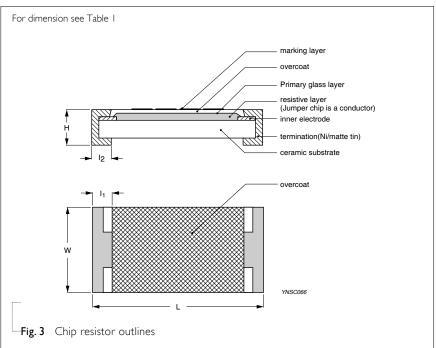
CONSTRUCTION

The resistor is constructed on top of a high-grade ceramic body. Internal metal electrodes are added on each end to make the contacts to the thick film resistive element. The composition of the resistive element is a noble metal imbedded into a glass and covered by a second glass to prevent environment influences. The resistor is laser trimmed to the rated resistance value. The resistor is covered with a protective epoxy coat, finally the two external terminations (matte tin on Nibarrier) are added. See fig.3

DIMENSIONS

Table I	
ТҮРЕ	RC2010
L (mm)	5.00 ± 0.10
W (mm)	2.50 ± 0.15
H (mm)	0.55 ± 0.10
lı (mm)	0.45 ± 0.15
l2 (mm)	0.50 ± 0.20

OUTLINES



Chip Resistor Surface Mount RC SERIES 2010 (ROHS Compliant)

9

ELECTRICAL CHARACTERISTICS

Table 2		
CHARACTERISTICS		RC2010 3/4 W
Operating Temperature Range	-55	5 °C to +155 °C
Maximum Working Voltage		200 V
Maximum Overload Voltage		500 V
Dielectric Withstanding Voltage		500 V
	5% (E24)	$\mid \Omega$ to 22 $M\Omega$
Resistance Range	1% (E24/E96)	$\mid \Omega$ to $\mid 0 \; \text{M}\Omega$
	Zero Ohm J	umper < 0.05 Ω
	$ \Omega \le R \le 0 \Omega $	±200 ppm/°C
Temperature Coefficient	$10 \text{ M}\Omega \le \text{R} \le 22 \text{ M}\Omega$	±200 ppm/°C
	$10 \Omega < R \le 10 M\Omega$	±100 ppm/°C
lumpor Critoria	Rated Current	2 A
Jumper Criteria	Maximum Current	10 A

FOOTPRINT AND SOLDERING PROFILES

For recommended footprint and soldering profiles, please see the special data sheet "Chip resistors mounting".

PACKING STYLE AND PACKAGING QUANTITY

Table 3	Packing style and packaging quantity	
---------	--------------------------------------	--

PRODUCT TYPE	PACKING STYLE	REEL DIMENSION	QUANTITY PER REEL
RC2010	Embossed taping reel (K)	7" (178 mm)	4,000 units

NOTE

I. For embossed tape and reel specification/dimensions, please see the special data sheet "Packing" document.

FUNCTIONAL DESCRIPTION

POWER RATING

RC2010 rated power at 70°C is 3/4 W

RATED VOLTAGE

The DC or AC (rms) continuous working voltage corresponding to the rated power is determined by the following formula:

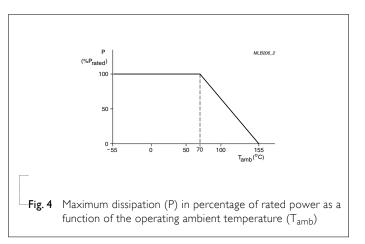
 $V=\sqrt{(P \times R)}$ or max. working voltage whichever is less

Where

V=Continuous rated DC or AC (rms) working voltage (V)

P=Rated power (W)

R=Resistance value (Ω)





Chip Resistor Surface Mount RC SERIES 2010 (ROHS Compliant)

<u>6</u> 9

TESTS AND REQUIREMENTS

Table 4 Test condition, procedure and requirements

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Temperature Coefficient of	IEC 60115-1 4.8	At +25/–55 °C and +25/+125 °C	Refer to table 2
Resistance (T.C.R.)		Formula:	
(1.0.1.)		T.C.R= $\frac{R_2-R_1}{R_1(t_2-t_1)} \times 10^6 \text{ (ppm/°C)}$	
		Where t_1 =+25 °C or specified room temperature	
		t_2 =-55 °C or +125 °C test temperature	
		R ₁ =resistance at reference temperature in ohms R ₂ =resistance at test temperature in ohms	
Life/Endurance	IEC 60115-1 4.25.1	At 70±5 °C for 1,000 hours, RCWV applied for 1.5 hours on, 0.5 hour off, still air required	$\pm (1.0\% + 0.05 \Omega)$ for 1% tol.
			\pm (3.0%+0.05 Ω) for 5% tol. <100 m Ω for Jumper
High	IEC 60068-2-2	1,000 hours at 155±5 °C, unpowered	±(1.0%+0.05 Ω) for 1% tol.
Temperature Exposure/			$\pm(2.0\%{+}0.05~\Omega)$ for 5% tol.
Endurance at Upper Category Temperature			<50 m Ω for Jumper
Moisture	MIL-STD-202G Method-106G	Each temperature / humidity cycle is defined at 8	$\pm(0.5\%{+}0.05~\Omega)$ for 1% tol.
Resistance		hours, 3 cycles / 24 hours for 10d. with 25 °C / 65 °C 95% R.H, without steps 7a & 7b, unpowered	\pm (2.0%+0.05 Ω) for 5% tol. <100 m Ω for Jumper
		Parts mounted on test-boards, without condensation on parts	
		Measurement at 24 ± 2 hours after test conclusion	
Thermal Shock	MIL-STD-202G Method-107G	-55/+125 °C	±(0.5%+0.05 Ω) for 1% tol.
		Number of cycles required is 300. Devices unmounted	\pm (1%+0.05 Ω) for 5% tol. <50 m Ω for Jumper
		Maximum transfer time is 20 seconds. Dwell time is 15 minutes. Air – Air	
Short Time	IEC60115-1 4.13	2.5 times of rated voltage or maximum overload	±(1.0%+0.05 Ω) for 1% tol.
Overload		voltage whichever is less for 5 sec at room temperature	\pm (2.0%+0.05 Ω) for 5% tol.
		temperature	$<$ 50 m Ω for Jumper

Chip Resistor Surface Mount RC SERIES 2010 (RoHS Compliant)

Product specification

7

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS	
Board Flex/	IEC 60068-2-21	Chips mounted on a 90mm glass epoxy resin	±(1.0%+0.05 Ω) for 1%	6, 5% tol
Bending		PCB (FR4)	$<$ 50 m Ω for Jumper	
		2 mm bending	No visible damage	
		Bending time: 60±5 seconds		
Low	IEC 60068-2-1	The resistor shall be subjected to a DC rated	±(0.5%+0.05 Ω) for 1%	s tol .
Temperature Operation		voltage for I.5 h-on, 0.5 h-off, at -55±3 °C	\pm (1.0%+0.05 Ω) for 5%	á tol.
Operation		This constitutes shall be repeated for 96 hours	No visible damage	
		However the applied voltage shall not exceed the maximum operating voltage		
Insulation	IEC 60115-1 4.6	Rated continuous overload voltage (RCOV)	≥10 GΩ	
Resistance		for I minute	2.0 011	
		Type RC2010		
		Voltage (DC) 100 V		
Dielectric	IEC 60115-1 4.7	Maximum voltage (V_{rms}) applied for 1 minute	No breakdown or flasho	over
Withstand Voltage		Type RC2010		
Voltage		Voltage (AC) 500 V _{rms}		
Resistance to Solvent	IPC/JEDEC J-STD-020D	Isopropylalcohol (C_3H_7OH) followed by brushing	No smeared	
Noise	IEC 60115-1 4.12	Maximum voltage (Vrms) applied	Resistors range	Value
			R < 100 Ω	10 dB
			$ 00 \ \Omega \leq R < K\Omega$	20 dB
			$ K\Omega \le R < 0 K\Omega$	30 dB
			$10 \text{ K}\Omega \leq \text{R} < 100 \text{ K}\Omega$	40 dB
			$100 \text{ K}\Omega \leq \text{R} < 1 \text{ M}\Omega$	46 dB
			$ M\Omega \le R \le 22 M\Omega$	48 dB
Biased Humidity (steady state)	IEC 60115-1 4.37	Steady state for 1000 hours at 40 °C / 95% R.H. RCWV applied for 1.5 hours on and 0.5 hour off	±(1.0%+0.05 Ω) for 1% ±(2.0%+0.05 Ω) for 5%	
			<100 m Ω for Jumper	

YAGEO Phicomp

Chip Resistor Surface Mount RC SERIES 2010 (ROHS Compliant)

Product specification 8 9

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Intermittent Overload	IEC 60115-1 4.39	2.5 times of rated voltage or maximum overload voltage whichever is less for 1 second on and 25 seconds off; total 10,000 cycles	\pm (1.0%+0.05 Ω) for 1% tol. \pm (2.0%+0.05 Ω) for 5% tol. <100 mΩ for Jumper
Solderability - Wetting	IPC/JEDEC J-STD-002B test B	Electrical Test not required	Well tinned (≥95% covered)
		Magnification 50X SMD conditions:	No visible damage
		I st step: method B, aging 4 hours at 155 °C dry heat	
		2^{nd} step: leadfree solder bath at 245±3 °C	
		Dipping time: 3±0.5 seconds	
- Leaching	IPC/JEDEC J-STD-002B test D	Leadfree solder, 260 °C, 30 seconds immersion time	No visible damage
- Resistance to	IEC 60068-2-58	Condition B, no pre-heat of samples	±(0.5%+0.05 Ω) for 1% tol .
Soldering Heat		Leadfree solder, 260 °C, 10 seconds immersion time	\pm (1.0%+0.05 Ω) for 5% tol. <50 mΩ for Jumper
		Procedure 2 for SMD: devices fluxed and cleaned with isopropanol	No visible damage

YAGEO Phicomp	
---------------	--

Chip Resistor Surface Mount RC SERIES 2010 (ROHS Compliant)

REVISION HISTORY

DATE	CHANGE NOTIFICATION	DESCRIPTION
Sep 22, 2009	-	- Test Items and methods updated
		- Test requirements upgraded
Jul 15, 2008	-	- Change to dual brand datasheet that describe RC2010 with RoHS compliant
		- Description of "Halogen Free Epoxy" added
		- Define global part number
Sep 16, 2004	-	- New datasheet for 2010 thick film 1% and 5% with lead-free terminations
		- Replace the 2010 part of pdf files: PRC111_1_5, PRC111_5_6
		- Test method and procedure updated
	Sep 22, 2009 Jul 15, 2008	Sep 22, 2009 - Jul 15, 2008 -

"Yageo reserves all the rights for revising the content of this datasheet without further notification, as long as the products itself are unchanged. Any product change will be announced by PCN."

9